

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-60V	11mΩ@-10V	-90A
	14mΩ@-4.5V	

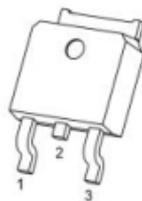
Feature

- High switching speed
- Improved dv/dt capability
- Low Gate Charge
- Low reverse transfer capacitance

Application

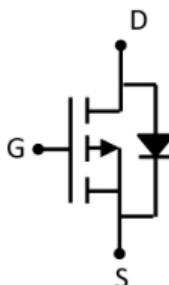
- Load Switches, Adaptor Switch
- Notebook PCs

Package

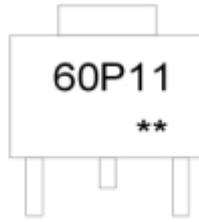


TO-263(G:1 D:2 S:3)

Circuit diagram



Marking



60P11 =Device Code
****** =Week Code

Absolute maximum ratings

(T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	-60	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous (T _c =25°C)	I _D	-90	A
Pulsed Drain Current	I _{DM}	-360	A
Single pulse avalanche energy	E _{AS}	361	mJ
Maximum Power Dissipation (T _c =25°C)	P _D	150	W
Thermal Resistance, Junction-to-Case	R _{θJC}	0.83	°C/W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55~+150	°C

Electrical characteristics

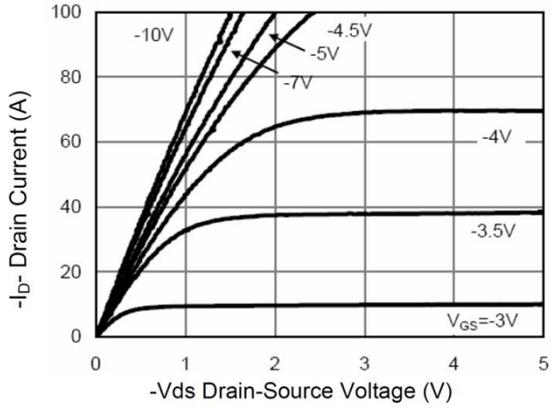
($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$BV_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-60			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -48V, V_{GS} = 0V$			-1	μA
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	μA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1	-1.5	-2.5	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -20A$		11	14	m Ω
		$V_{GS} = -4.5V, I_D = -20A$		14	18.5	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = -30V, V_{GS} = 0V,$ $f = 1MHz$		7700		pF
Output Capacitance	C_{oss}			489		
Reverse Transfer Capacitance	C_{rss}			364		
Switching Characteristics						
Turn-on Delay Time	$T_{d(on)}$	$V_{DD} = -30V, R_L = 4.7\Omega,$ $V_{GEN} = -10V, R_{GEN} = 3\Omega$		9.8		nS
Turn-on Rise Time	T_r			6.1		
Turn-off Delay Time	$T_{d(off)}$			44		
Turn-off Fall Time	T_f			12.7		
Total Gate Charge	Q_g	$V_{DS} = -30V, V_{GS} = -10V,$ $I_D = -20A$		85.5	55	nC
Gate-Source Charge	Q_{gs}			12.1		
Gate-Drain Charge	Q_{gd}			23.2		
Drain-Source Diode Characteristics						
Diode Forward Voltage	V_{SD}	$I_{SD} = -1A, V_{GS} = 0V$			-1.2	V

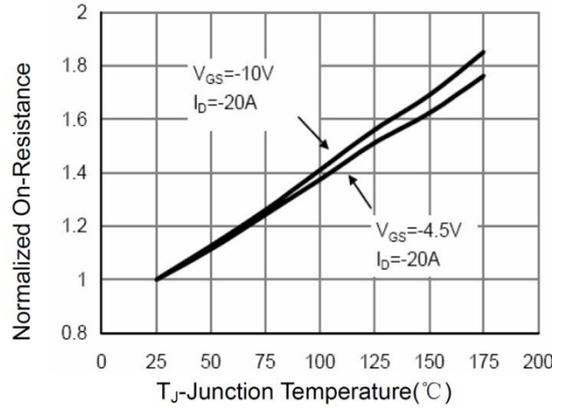
Notes:

1. E_{AS} condition: $T_j = 25^\circ\text{C}, V_{DD} = -30V, V_G = -10V, L = 0.5mH, R_g = 25\Omega$

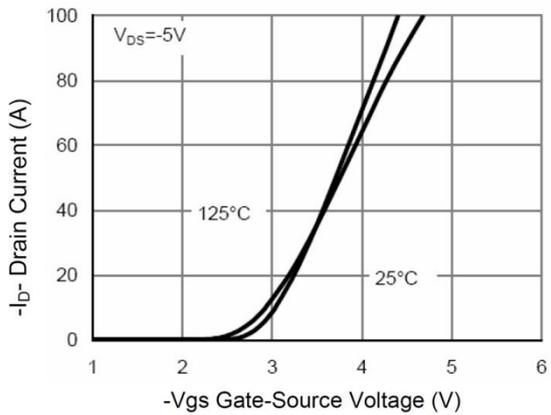
Typical Characteristics



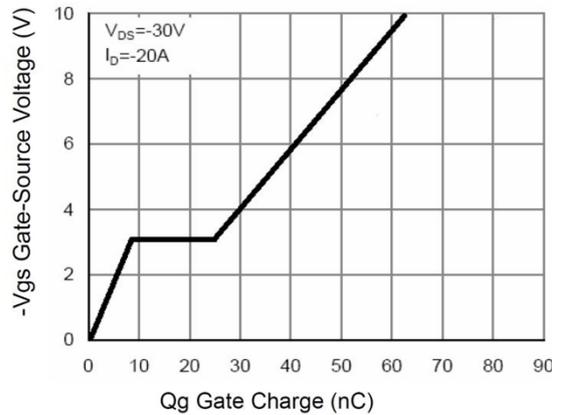
Output Characteristics



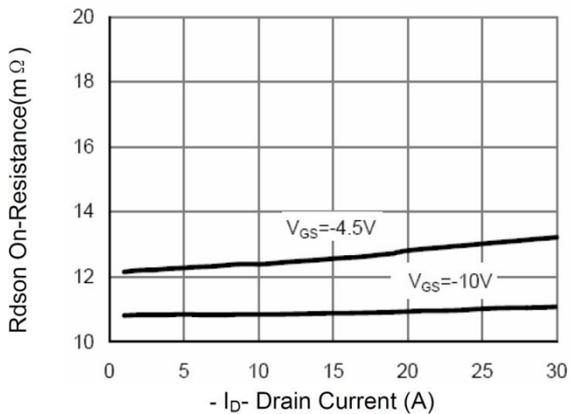
R_{dson} -Junction Temperature



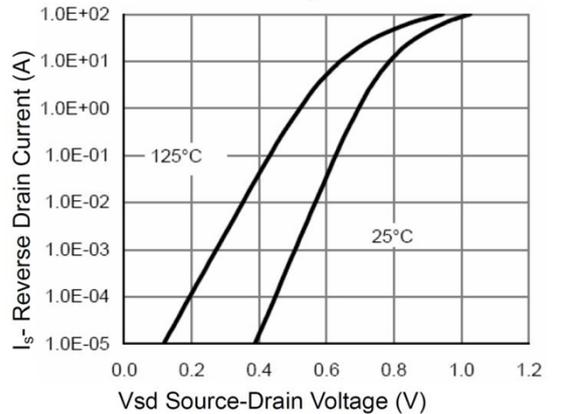
Transfer Characteristics



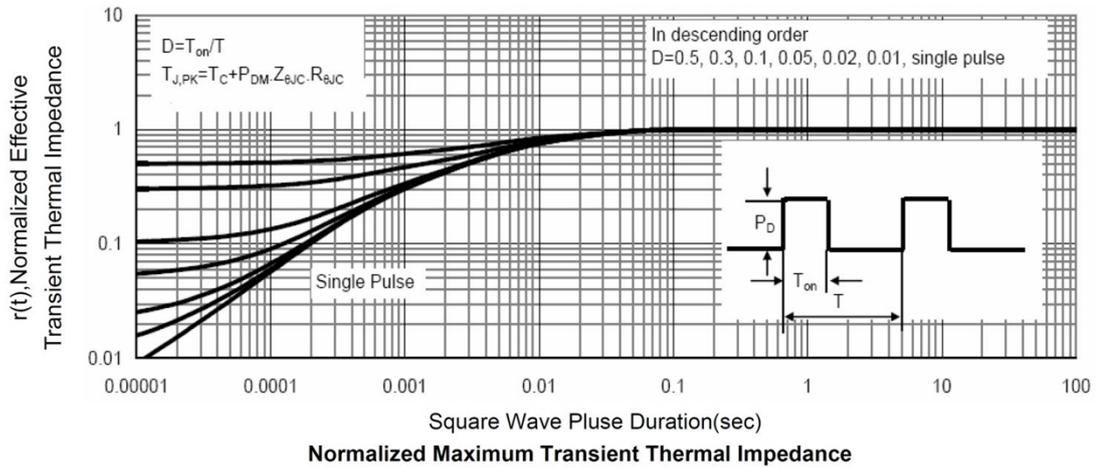
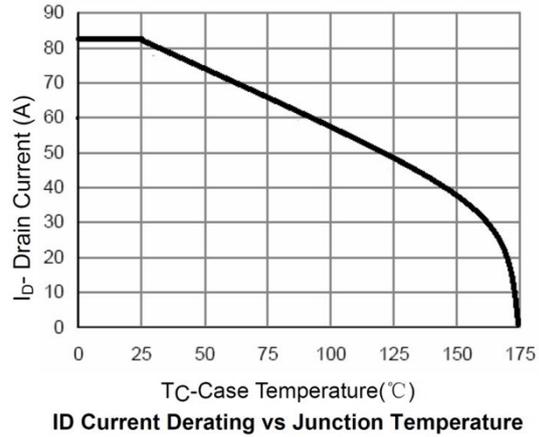
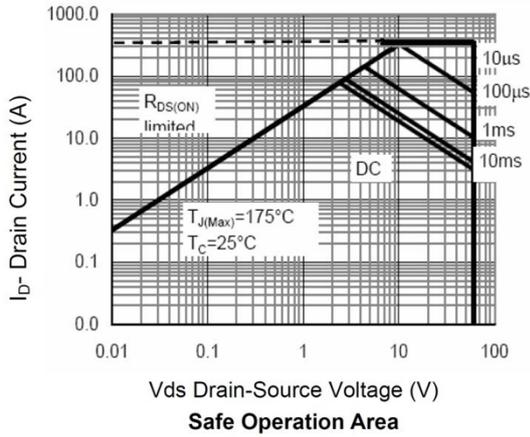
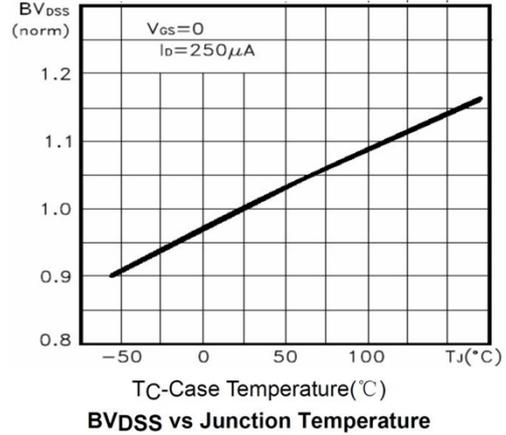
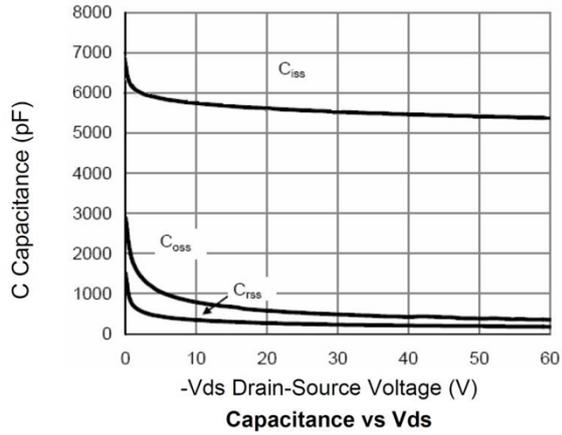
Gate Charge



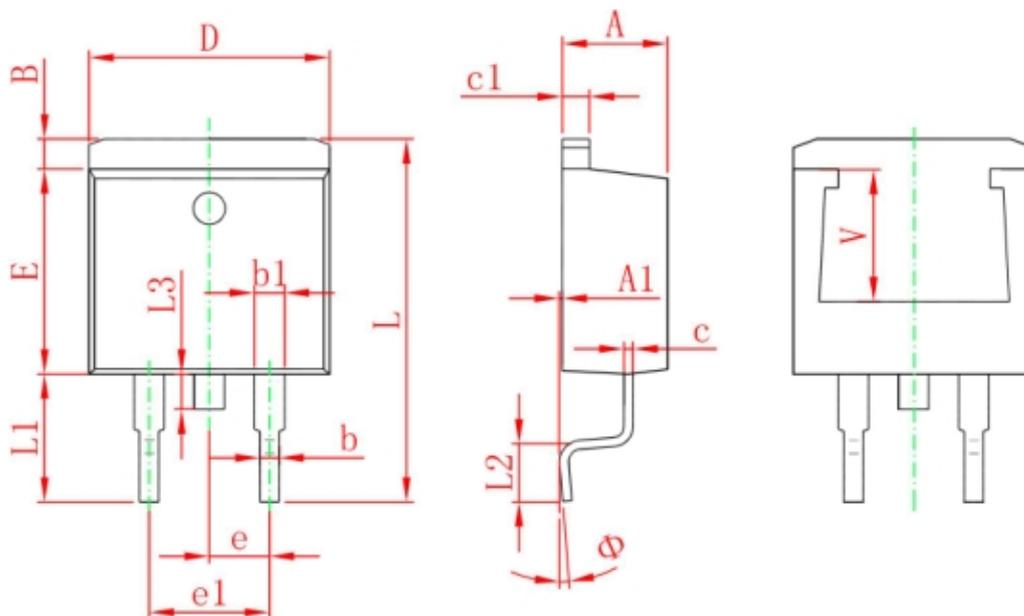
R_{dson} - Drain Current



Source- Drain Diode Forward



TO-263 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.120	1.420	0.044	0.056
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	14.940	15.500	0.588	0.610
L1	4.950	5.450	0.195	0.215
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
Φ	0°	8°	0°	8°
V	5.600 REF.		0.220 REF.	